



20V P-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	R _{DS(ON)}	I _D Tc = +25°C
-20V	5.5mΩ @ V _{GS} = -10V	-84A
-20V	7.0mΩ @ V _{GS} = -4.5V	-75A

Description and Applications

This new generation MOSFET is designed to minimize R_{DS(ON)} yet maintain superior switching performance. This device is ideal for use in power management and load switch.

- DC-DC Converters
- Load Switch

Features

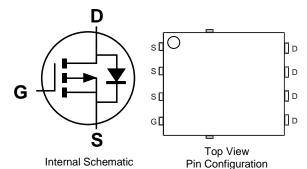
- Thermally Efficient Package-Cooler Running Applications
- <1.1mm Package Profile Ideal for Thin Applications
- High Conversion Efficiency
- Low R_{DS(ON)} Minimizes On State Losses
- Low Input Capacitance
- Fast Switching Speed
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/guality/product-definitions/

Mechanical Data

- Case: PowerDI[®]5060-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (§3)
- Weight: 0.097 grams (Approximate)







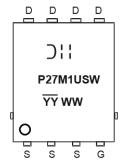
Ordering Information (Note 4)

Part Number	Case	Packaging	
DMP27M1UPSW-13	PowerDI5060-8 (SWP) (Type UX)	2,500 / Tape & Reel	

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



⊃¦¦ = Manufacturer's Marking
 P27M1USW= Product Type Marking Code
 YYWW = Date Code Marking
 YY = Year (ex: 21 = 2021)
 WW = Week (01 to 53)



Maximum Ratings (@ $T_C = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	VDSS	-20	V		
Gate-Source Voltage	V_{GSS}	±12	V		
Continuous Drain Current, V _{GS} = 10V (Note 7)	ΙD	-84 -68	А		
Maximum Continuous Body Diode Forward Current (Not	Is	-3.8	Α		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	-179	Α		
Pulsed Body Diode Forward Current (10µs Pulse, Duty 0	lsм	-179	Α		
Avalanche Current, L=0.1mH (Note 8)			las	-33	Α
Avalanche Energy, L=0.1mH (Note 8)	E _{AS}	54	mJ		

Thermal Characteristics (@Tc = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T _A = +25°C	PD	1.95	W
Thermal Resistance, Junction to Ambient (Note 5)		RθJA	64	°C/W
Total Power Dissipation (Note 6)	T _C = +25°C	P _D	3.57	W
Thermal Resistance, Junction to Case (Note 6)		Rеjc	35	°C/W
Thermal Resistance, Junction to Case (Note 7)		Rejc	2.1	°C/W
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics ($@T_C = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 9)							
Drain-Source Breakdown Voltage	BVDSS	-20			V	$V_{GS} = 0V$, $I_{D} = -250\mu A$	
Zero Gate Voltage Drain Current	IDSS		_	-1	μΑ	V _{DS} = -16V, V _{GS} = 0V	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 8V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 9)							
Gate Threshold Voltage	V _{GS(TH)}	-0.4	1	-1.3	٧	$V_{DS} = V_{GS}$, $I_D = -250\mu A$	
			3.6	5.5		$V_{GS} = -10V, I_{D} = -15A$	
Static Drain-Source On-Resistance	RDS(ON)		4.4	7.0	mΩ	$V_{GS} = -4.5V$, $I_{D} = -15A$	
		_	6.5	9.0		$V_{GS} = -2.5V$, $I_{D} = -10A$	
Diode Forward Voltage	V_{SD}	_	-0.7	-1.2	V	V _G S = 0V, I _S = -10A	
DYNAMIC CHARACTERISTICS (Note 10)							
Input Capacitance	Ciss		4777	_		V _{DS} = -10V, V _{GS} = 0V f = 1.0MHz	
Output Capacitance	Coss	_	591	_	pF		
Reverse Transfer Capacitance	Crss	_	518	_			
Gate Resistance	Rg	_	2.9	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1.0MHz$	
Total Gate Charge (V _{GS} = -4.5V)	Qg	_	55	_		V _{DD} = -10V, I _D = -20A	
Total Gate Charge (V _{GS} = -10V)	Qg	_	123	_	nC		
Gate-Source Charge	Qgs	_	9.6	_	nC		
Gate-Drain Charge	Q _{gd}	_	15.9	_			
Turn-On Delay Time	t _{D(ON)}		25	_		$V_{GS} = -4.5V, V_{DD} = -10V,$ $R_{G} = 1\Omega, I_{D} = -10A$	
Turn-On Rise Time	tR	_	84	_			
Turn-Off Delay Time	tD(OFF)		120	_	ns		
Turn-Off Fall Time	tr		128	_			
Reverse Recovery Time	trr		20	_	ns	1 404 11/14 4004/	
Reverse Recovery Charge	Q _{RR}	_	11	_	nC	-I _F = -10A, di/dt = 100A/μs	

Notes:

- 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
- 6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
 7. Thermal resistance from junction to soldering point (on the exposed drain pad).
- 8. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep T_J = +25°C.
- 9. Short duration pulse test used to minimize self-heating effect.
- 10. Guaranteed by design. Not subject to product testing.



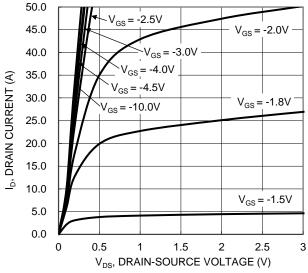


Figure 1. Typical Output Characteristic

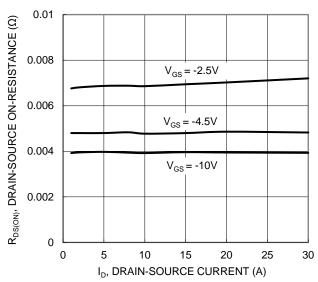


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

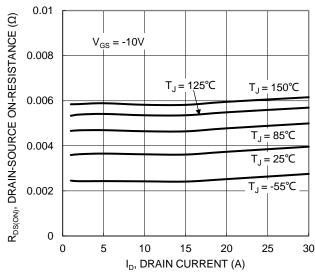


Figure 5. Typical On-Resistance vs. Drain Current and Temperature

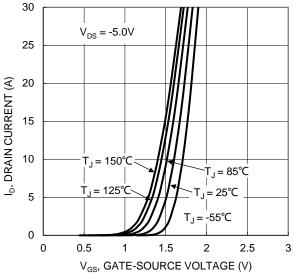


Figure 2. Typical Transfer Characteristic

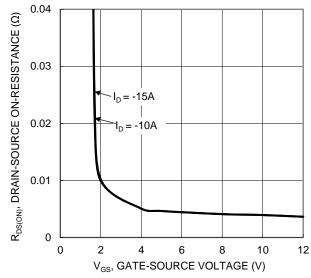


Figure 4. Typical Transfer Characteristic

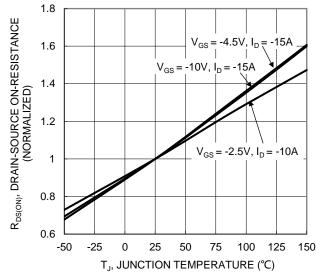


Figure 6. On-Resistance Variation with Temperature



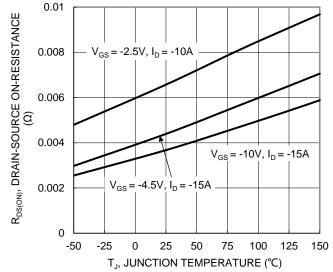


Figure 7. On-Resistance Variation with Temperature

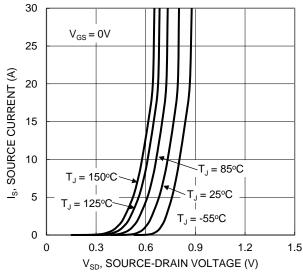


Figure 9. Diode Forward Voltage vs. Current

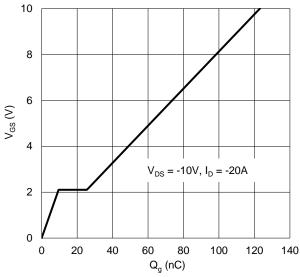


Figure 11. Gate Charge

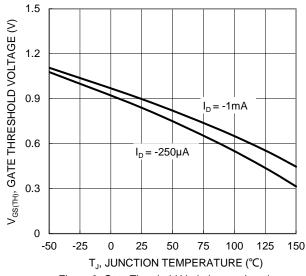


Figure 8. Gate Threshold Variation vs. Junction Temperature

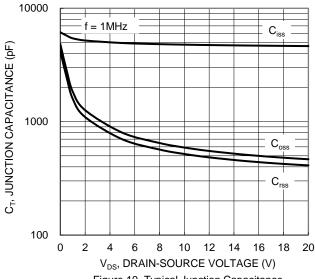
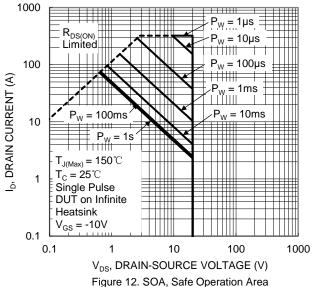


Figure 10. Typical Junction Capacitance





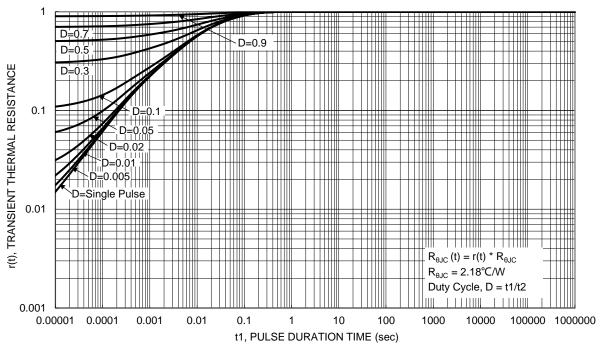


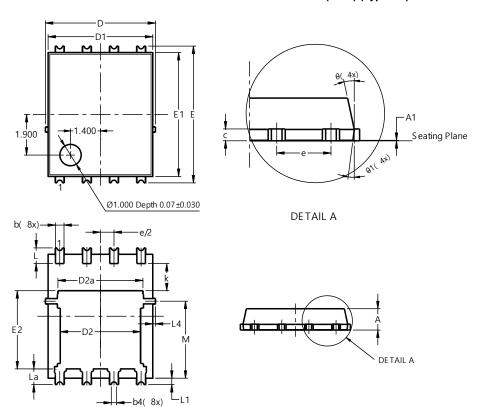
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8 (SWP) (Type UX)

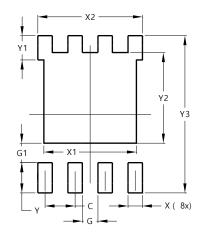


PowerDI5060-8 (SWP)					
(Type UX)					
Dim	Min	Max	Тур		
Α	0.90	1.10	1.00		
A 1	0	0.05			
b	0.30	0.50	0.41		
b2	0.20	0.35	0.25		
b4).25REF			
С	0.230	0.330	0.277		
D	5	.15 BS0			
D1	4.70	5.10	4.90		
D2	3.56	3.96	3.76		
D2a	3.78	3.98			
Е		.40 BS0			
E1	5.60	6.00	5.80		
E2	3.46	3.86	3.66		
E2a	4.195	4.595	4.395		
е	1.27BSC				
k	1.05				
L	0.635	0.835	0.735		
La	0.635	0.835	0.735		
L1	0.200	0.400	0.300		
L1a	0.050REF				
L4	0.025	0.225	0.125		
M	3.205	4.005	3.605		
θ	10°	12°	11°		
θ1	6°	8°	7°		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8 (SWP) (Type UX)



Dimensions	Value		
Dillicitations	(in mm)		
C	1.270		
G	0.660		
G1	0.820		
X	0.610		
X1	4.100		
X2	4.420		
Y	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		

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